

MASW-011127 Rev. V1

Features

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- High Power High Linearity SP4T Switch
- Broadband: DC 4.2 GHz
- No External Matching Components Required
 Insertion Loss:
 - 0.55 dB @ 2.3 GHz 0.7 dB @ 3.5 GHz
- Input P0.1dB: 42 dBm
- Input IP3: 78 dBm
- Dual 5 V & -3.4 V Supplies
- Fast Switching
- Integrated Control Circuitry with 1.8 V Logic
- Lead-Free 4 mm 20 Lead QFN Package
- RoHS* Compliant

Applications

- 5G Massive MIMO
- Wireless Infrastructure
- General Wireless

Description

The MASW-011127 is a compact surface mount, highly integrated, high power SP4T switch in a compact 4 mm QFN package. All the bias circuitry and matching components are internal to the module.

This switch operates from DC - 4.2 GHz and features high power handling, high linearity and low power consumption. The switch requires 5 V and - 3.4 V supplies. There are three control pins V1, V2 and SEL and are 1.8 V CMOS compatible.

A select pin allows re-configurability of the control logic for extra flexibility.

Ordering Information¹

Part Number	Package
MASW-011127-TR1000	1000 part reel
MASW-011127-001SMB	Sample Board

1. Reference Application Note M513 for reel size information.

Functional Schematic



Pin Names²

Pin #	Function
1,2,4,5,7,8,10,16,18,19	NC
3	RF COM
6	RF1
9	RF2
11	V1
12	V2
13	SEL
14	V _{CC2}
15	V _{CC1}
17	RF3
20	RF4
21	Paddle ³

MACOM recommends connecting unused package pins to ground.

The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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Pin Description

Pin #	Name	Description
1, 2, 4, 5, 7, 8, 10, 16, 18, 19	NC	Not internally connected. Recommend to be connected to RF/DC ground
3	RF COM	RF Common Port. The RF COM pin is DC-coupled to 0 V and AC matched to 50 Ω . No DC blocking capacitor is required when the RF line potential is equal to 0 V DC.
6	RF1	Switch RF Port 1. The RF1 pin is DC-coupled to 0 V and AC matched to 50 Ω . No DC blocking capacitor is required when the RF line potential is equal to 0 V DC.
9	RF2	Switch RF Port 2. The RF2 pin is DC-coupled to 0 V and AC matched to 50 Ω . No DC blocking capacitor is required when the RF line potential is equal to 0 V DC.
11	V1	Control Logic Input 1. No internal pull-up/down resistor.
12	V2	Control Logic Input 2. No internal pull-up/down resistor.
13	SEL	Control Logic Input Select. No internal pull-up/down resistor.
14	V _{CC2}	Negative Supply, VCC2 = -3.4 V
15	V _{CC1}	Positive Supply VCC1 = 5 V
17	RF3	Switch RF Port 3. The RF3 pin is DC-coupled to 0 V and AC matched to 50 Ω . No DC blocking capacitor is required when the RF line potential is equal to 0 V DC.
20	RF4	Switch RF Port 4. The RF4 pin is DC-coupled to 0 V and AC matched to 50 Ω . No DC blocking capacitor is required when the RF line potential is equal to 0 V DC.
Paddle	GND	Exposed Pad. The exposed pad must be connected to a large RF/DC ground island providing thermal capabilities for heat dissipation

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Recommended Operating Conditions

Parameter	Conditions	Unit	Min.	Тур.	Max.
RF Port Input Power	RF COM, RF1, RF2, RF3, RF4, 3.5 GHz CW LTE	dBm	_	_	42.5 40.0
Digital Logic Input V1, V2, SEL	V1, V2, SEL	V	-0.3	—	2.25
DC Positive Supply (V _{CC1})	_	V	4.75	5.0	5.25
DC Negative Supply (V _{CC2})		V	-3.55	-3.4	-3.25
Operating Temperature ⁴		°C	-40	—	+105
Junction Temperature ^{5,6}	_	°C	—		+125
Storage Temperature	—	°C	-65	—	+150

4. Operating/Case Temperature (T_c) is measured at the exposed pad.
5. Operating at nominal conditions with T_J ≤ +125°C will ensure MTTF > 1 x 10⁶ hours.
6. Junction Temperature (T_J) = T_c + Θjc * P_{DISS} Typical thermal resistance (Θjc) = 11.4 °C/W.

P_{DISS} is the total dissipated DC and RF power.

Absolute Maximum Ratings^{7,8}

Parameter	Conditions		Min.	Тур.	Max.
RF Port Input Power	RF COM, RF1, RF2, RF3, RF4, 3.5 GHz CW LTE	dBm	_	_	43.0 40.5
Digital Logic Input V1, V2, SEL	V1, V2, SEL	V	-0.3	—	3.6
DC Positive Supply (V _{CC1})		V	-0.3		6.0
DC Negative Supply (V _{CC2})		V	-3.6		-3.0
Junction Temperature ^{7,8}		°C	_		+135
Storage Temperature	_	°C	-65	—	+150

7. Exceeding any one or combination of these limits may cause permanent damage to this device.

8. MACOM does not recommend sustained operation near these survivability limits.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1C, CDM Class C2A devices.

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AC Electrical Specifications: P_{IN} = -10 dBm, T_A = 25 °C, V_{CC1} = +5 V, V_{CC2} = -3.4 V, Z_0 = 50 Ω

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Insertion Loss (All Paths)	150 MHz 1.0 GHz 2.3 GHz 3.5 GHz	dB	_	0.25 0.3 0.55 0.70	 0.8
Isolation (RF COM-RF1 & RF COM-RF4)	150 MHz 1.0 GHz 2.3 GHz 3.5 GHz	150 MHz 1.0 GHz 2.3 GHz 3.5 GHz		60 42 32 28	
Isolation (RF COM-RF2 & RF COM-RF3)	150 MHz 1.0 GHz 2.3 GHz 3.5 GHz	dB	 27 	60 42 32 26	_
Return Loss (All RF ports)	150 MHz 1.0 GHz 2.3 GHz 3.5 GHz	dB	_	45 26 17 16	_
Phase difference (All RF ports)	2.3 GHz	٥	_	1.8	_
Two-Tone Input IP3	Two-Tone, P _{IN} /Tone = +34 dBm, 50 MHz Tone Spacing, 3.5 GHz	dBm		78	_
Input P0.1dB 150 MHz 2.0 GHz 3.5 GHz		dBm	_	41.8 42.0 41.5	

DC Electrical Specifications: $V_{CC1} = +5 V$, $V_{CC2} = -3.4 V$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Supply Voltage 1	V _{CC1}	V	—	5	—
Supply 1 Current	I _{CC1}	mA	_	0.5	—
Supply Voltage 2	V _{CC2}	V		-3.4	—
Supply 2 Current	I _{CC2}	mA		0.5	—
Control Voltage (pins SEL,V1,V2)	Logic High Logic Low	V	1.2 -0.3	1.8 0	2.25 0.6
Logic Input Current (pins SEL,V1,V2)	Logic High Logic Low	μA	-10	_	10

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For further information and support please visit: <u>https://www.macom.com/support</u>

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Transient Electrical Specifications: V_{CC1} = 5 V, V_{CC2} = -3.4 V

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Settling Time	50% V _{CTRL} to gain settled to IL +/- 0.5 dB RF = 3.5 GHz	us		0.9	_

Control Truth Table

For SEL=0				For SEL=1	
Path to COM	V2	V1	Path to COM	V2	V1
RF1	0	0	RF1	1	1
RF2	0	1	RF2	1	0
RF3	1	0	RF3	0	1
RF4	1	1	RF4	0	0

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PCB Layout



Parts List						
Part	Value	Case Style				
C1, C4	10 µF	0603				
C2, C5	470 pF	0402				
C3, C6	10 nF	0402				
C7-9	5 pF	0402				
R1, R4, R7	0 Ω	0402				
R2, R5, R8	1 kΩ	0402				
R3, R6, R9	47 kΩ	0402				
J1-5	142-0761-841	SMA, End Launch				

Application Schematic



Power Supplies

De-coupling capacitors should be placed at the V_{CC1} and V_{CC2} supply pin to minimize noise and fast transients. Supply voltage change or transients should have a slew rate smaller than 1 V / 10 μ s. In addition, all control pins should remain at 0 V (+/- 0.3 V) and no RF power should be applied while the supply voltage ramps or while it returns to zero.

 V_{CC1} and V_{CC2} can be sequenced in any order at power up or power down.

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Typical Performance Curves: P_{IN} = -10 dBm, V_{CC1} = 5 V, V_{CC2} = -3.4 V, Z_0 = 50 Ω

Switch Insertion Loss⁹, RFCOM-RF1



Switch Insertion Loss⁹, RFCOM-RF3



Switch Insertion Loss⁹, RFCOM-RF2



Switch Insertion Loss⁹, RFCOM-RF4



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Typical Performance Curves: P_{IN} = -10 dBm, V_{CC1} = 5 V, V_{CC2} = -3.4 V, Z_0 = 50 Ω

RF1 Return Loss⁹, RFCOM-RF1



RF2 Return Loss⁹, RFCOM-RF2



RF3 Return Loss⁹, RFCOM-RF3



RF4 Return Loss⁹, RFCOM-RF4



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Typical Performance Curves: P_{IN} = -10 dBm, V_{CC1} = 5 V, V_{CC2} =-3.4 V, Z_0 =50 Ω

Switch Isolation⁹, RFCOM-RF1



Switch Isolation⁹, RFCOM-RF3



Compression P0.1dB⁹



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Switch Isolation⁹, RFCOM-RF2



Switch Isolation⁹, RFCOM-RF4



9. For insertion loss, isolation, and compression plots, RF trace and connector losses are de-embedded.

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Lead-Free 4 mm 20-Lead PQFN[†]



[†] Reference Application Note S2083 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements in accordance to JEDEC J-STD-020D. Plating is Sn over Cu.

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